

# 4-Mbit (512K X 8) Static RAM

### **Features**

- Temperature ranges
  - □ Commercial: 0°C to 70°C
  - ☐ Industrial/Automotive -A: —40°C to 85°C
  - ☐ Automotive-E: -40°C to 125°C
- High speed
  □ t<sub>AA</sub> = 10 ns
- Low active power ☐ 324 mW (max)
- 2.0 V data retention
- Automatic power down when deselected
- TTL-compatible inputs and outputs
- Easy memory expansion with CE and OE features

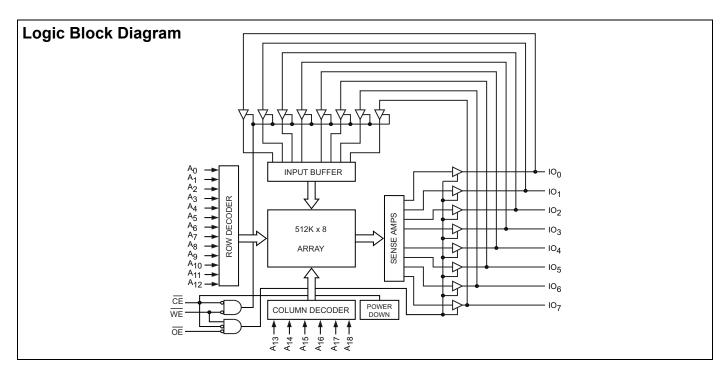
### **Functional Description**

The CY7C1049CV33 is a high performance CMOS Static RAM organized as 524,288 words by eight bits. Easy memory expansion is provided by an active LOW Chip Enable ( $\overline{\text{CE}}$ ), an active LOW Output Enable ( $\overline{\text{OE}}$ ), and three-state drivers. Writing to the device is accomplished by taking Chip Enable ( $\overline{\text{CE}}$ ) and Write Enable ( $\overline{\text{WE}}$ ) inputs LOW. Data on the eight I/O pins (I/O<sub>0</sub> through I/O<sub>7</sub>) is then written into the location specified on the address pins ( $A_0$  through  $A_{18}$ ).

The eight input and output pins (I/O $_0$  through I/O $_7$ ) are place<u>d in</u> a high impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), or during a write operation (CE LOW, and WE LOW).

The CY7C1049CV33 is available in standard 400-mil-wide 36-pin SOJ package and 44-pin TSOP II package with center power and ground (revolutionary) pinout.

For best practice recommendations, refer to the Cypress application note AN1064, SRAM System Guidelines.



# CY7C1049CV33



## Contents

| Features                     |   |
|------------------------------|---|
| Functional Description       | 1 |
| Selection Guide              | 3 |
| Pin Configuration            | 3 |
| Pin Definitions              | 3 |
| Maximum Ratings              | 4 |
| Operating Range              |   |
| Electrical Characteristics   | 4 |
| Capacitance                  | 4 |
| Thermal Resistance           |   |
| AC Switching Characteristics | 6 |

| Switching Waveforms                     | 7  |
|---|----|
| Truth Table                             |    |
| Ordering Code Definitions               | 9  |
| Ordering Information                    | 9  |
| Package Diagrams                        |    |
| Acronyms                                | 11 |
| Document History Page                   | 12 |
| Sales, Solutions, and Legal Information | 13 |
| Worldwide Sales and Design Support      | 13 |
| Products                                |    |
| PSoC Solutions                          | 13 |



### **Selection Guide**

|                              | Description                         |     |    |    | Unit |
|------------------------------|-------------------------------------|-----|----|----|------|
| Maximum Access Time          |                                     | 10  | 12 | 15 | ns   |
| Maximum Operating Current    | Commercial                          | 90  | 85 | -  | mA   |
|                              | Industrial/Automotive-A             | 100 | 95 | -  | mA   |
|                              | Automotive-E                        | -   | -  | 95 | mA   |
| Maximum CMOS Standby Current | Commercial/Industrial/ Automotive-A | 10  | 10 | -  | mA   |
|                              | Automotive-E                        | -   | -  | 15 | mA   |

## **Pin Configuration**

Figure 1. 36-Pin SOJ (Top View)

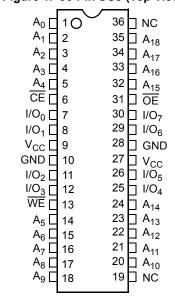
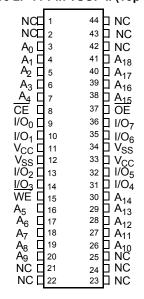


Figure 2. 44-Pin TSOP II (Top View)



### **Pin Definitions**

| Pin Name                           | 36 SOJ<br>Pin Number      | 44 TSOP II<br>Pin Number         | I/O Type      | Description   |
|------------------------------------|---------------------------|----------------------------------|---------------|---|
| A <sub>0</sub> -A <sub>18</sub>    | 1–5,14–18,<br>20–24,32–35 | 3–7,16–20,<br>26–30,38–41        | Input         | Address inputs used to select one of the address locations.   |
| I/O <sub>0</sub> –I/O <sub>7</sub> | 7,8,11,12,25,<br>26,29,30 | 9,10,13,14,<br>31,32,35,36       | Input/Output  | <b>Bidirectional data I/O lines.</b> Used as input or output lines depending on operation   |
| NC <sup>[1]</sup>                  | 19,36                     | 1,2,21,22,23,2<br>4,25,42,43, 44 | No Connect    | No connects. This pin is not connected to the die   |
| WE                                 | 13                        | 15                               | Input/Control | <b>Write Enable input, active LOW.</b> When selected LOW, a WRITE is conducted. When selected HIGH, a READ is conducted.  |
| CE                                 | 6                         | 8                                | Input/Control | <b>Chip Enable input, active LOW.</b> When LOW, selects the chip. When HIGH, deselects the chip.  |
| ŌĒ                                 | 31                        | 37                               | Input/Control | <b>Output Enable, active LOW.</b> Controls the direction of the I/O pins. When LOW, the I/O pins are allowed to behave as outputs. When deasserted HIGH, I/O pins are three-stated, and act as input data pins. |
| V <sub>SS</sub> , GND              | 10,28                     | 12,34                            | Ground        | <b>Ground for the device.</b> Should be connected to ground of the system.  |
| V <sub>CC</sub>                    | 9,27                      | 11,33                            | Power Supply  | Power supply inputs to the device.  |

### Note

<sup>1.</sup> NC pins are not connected on the die.



## **Maximum Ratings**

Exceeding maximum ratings may impair the useful life of the device. These user guidelines are not tested.

Ambient Temperature with

Supply Voltage on  $V_{CC}$  to Relative GND<sup>[2]</sup> $\!-\!0.5$  V to +4.6 VDC

Voltage Applied to Outputs

# Input Voltage<sup>[2]</sup> ...... $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$

### **Operating Range**

| Range                       | Ambient Temperature | V <sub>CC</sub>   |
|-----------------------------|---------------------|-------------------|
| Commercial                  | 0°C to +70°C        | 3.3 V $\pm$ 0.3 V |
| Industrial/<br>Automotive-A | –40°C to +85°C      |                   |
| Automotive-E                | -40°C to +125°C     |                   |

### **Electrical Characteristics**

Over the Operating Range

| Parameter        | Description                        | Tost Condition   | Test Conditions        |      | 10                    | -    | 12                       | -    | 15                       | Unit  |
|------------------|------------------------------------|--|------------------------|------|-----------------------|------|--------------------------|------|--------------------------|-------|
| Farameter        | Description                        | Test Condition   | 13                     | Min  | Max                   | Min  | Max                      | Min  | Max                      | Oilit |
| V <sub>OH</sub>  | Output HIGH Voltage                | $V_{CC} = Min.; I_{OH} = -4.0 \text{ mA}$  |                        | 2.4  |                       | 2.4  |                          | 2.4  |                          | V     |
| V <sub>OL</sub>  | Output LOW Voltage                 | $V_{CC} = Min.,; I_{OL} = 8.0 \text{ mA}$  |                        |      | 0.4                   |      | 0.4                      |      | 0.4                      | V     |
| V <sub>IH</sub>  | Input HIGH Voltage                 |  |                        | 2.0  | V <sub>CC</sub> + 0.3 | 2.0  | V <sub>CC</sub><br>+ 0.3 | 2.0  | V <sub>CC</sub><br>+ 0.3 | V     |
| V <sub>IL</sub>  | Input LOW Voltage <sup>[2]</sup>   |  |                        | -0.3 | 0.8                   | -0.3 | 8.0                      | -0.3 | 0.8                      | V     |
| I <sub>IX</sub>  | Input Load Current                 | $GND \leq V_I \leq V_CC$   | Com'l/Ind'l/<br>Auto-A | -1   | +1                    | -1   | +1                       |      |                          | μА    |
|                  |                                    |  | Auto-E                 |      |                       |      |                          | -20  | +20                      |       |
| I <sub>CC</sub>  | V <sub>CC</sub> Operating          | V <sub>CC</sub> = Max.,  | Com'l                  |      | 90                    |      | 85                       |      |                          | mA    |
|                  | Supply Current                     | $f = f_{MAX} = 1/t_{RC}$   | Ind'I/Auto-A           |      | 100                   |      | 95                       |      |                          |       |
|                  |                                    |  | Auto-E                 |      |                       |      |                          |      | 95                       |       |
| I <sub>SB1</sub> | Automatic CE<br>Power Down Current | Max. $V_{CC}$ , $\overline{CE} \ge V_{IH}$ ; $V_{IN} \ge V_{IH}$ or                      | Com'l/Ind'l/<br>Auto-A |      | 40                    |      | 40                       |      |                          | mA    |
|                  | —TTL Inputs                        | $V_{IN} \leq V_{IL}$ , $f = f_{MAX}$   | Auto-E                 |      |                       |      |                          |      | 45                       | mA    |
| I <sub>SB2</sub> | Automatic CE<br>Power Down Current | $\frac{\text{Max. V}_{\text{CC}},}{\text{CE}} \ge \text{V}_{\text{CC}} - 0.3 \text{ V},$ | Com'l/Ind'l/<br>Auto-A |      | 10                    |      | 10                       |      |                          | mA    |
|                  | —CMOS Inputs                       | $V_{IN} \ge V_{CC} - 0.3 \text{ V},$<br>or $V_{IN} \le 0.3 \text{ V}, f = 0$             | Auto-E                 |      |                       |      |                          |      | 15                       | mA    |

### Capacitance

Tested initially and after any design or process changes that may affect these parameters.

| Parameter        | Description       | Test Conditions                    | Max | Unit |
|------------------|-------------------|------------------------------------|-----|------|
| C <sub>IN</sub>  | Input Capacitance | $T_A = 25^{\circ}C$ , $f = 1$ MHz, | 8   | pF   |
| C <sub>OUT</sub> | I/O Capacitance   | V <sub>CC</sub> = 3.3 V            | 8   | pF   |

### **Thermal Resistance**

Tested initially and after any design or process changes that may affect these parameters.

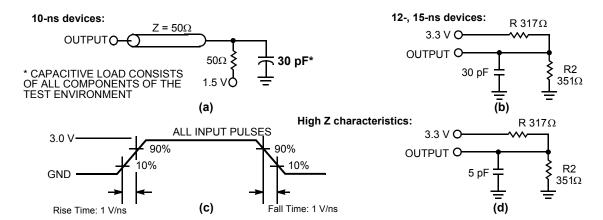
| Parameter     | Description | Test Conditions   | 36-Pin SOJ | 44-TSOP-II | Unit |
|---------------|-------------|---|------------|------------|------|
| $\Theta_{JA}$ | to Ambient) | Test conditions follow standard test methods and procedures for | 46.51      | 41.66      | °C/W |
| $\Theta_{JC}$ |             | measuring thermal impedance,<br>per EIA / JESD51.               | 18.8       | 10.56      | °C/W |

### Notes

- 2. V<sub>IL</sub> (min) = -2.0 V and V<sub>IH</sub>(max) = V<sub>CC</sub> + 0.5 V for pulse durations of less than 20 ns.
   3. Tested initially and after any design or process changes that may affect these parameters.



Figure 3. AC Test Loads and Waveforms [4]



### Notes

Tested initially and after any design or process changes that may affect these parameters.
 AC characteristics (except High Z) for 10 ns parts are tested using the load conditions shown in Figure (a). All other speeds are tested using the Thevenin load shown in Figure (b). High Z characteristics are tested for all speeds using the test load shown in Figure (d).



### **AC Switching Characteristics**

Over the Operating Range [6]

|                                   |   | -1       | 0   | -   | -12 | -   | 15  |          |
|-----------------------------------|---|----------|-----|-----|-----|-----|-----|----------|
| Parameter                         | Description                                   | Min      | Max | Min | Max | Min | Max | Unit     |
| Read Cycle                        |   | <u> </u> | •   |     |     |     |     | <b>-</b> |
| t <sub>power</sub> <sup>[7]</sup> | V <sub>CC</sub> (typical) to the first access | 100      |     | 100 |     | 100 |     | μS       |
| t <sub>RC</sub>                   | Read Cycle Time                               | 10       |     | 12  |     | 15  |     | ns       |
| t <sub>AA</sub>                   | Address to Data Valid                         |          | 10  |     | 12  |     | 15  | ns       |
| t <sub>OHA</sub>                  | Data Hold from Address Change                 | 3        |     | 3   |     |     | 3   | ns       |
| t <sub>ACE</sub>                  | CE LOW to Data Valid                          |          | 10  |     | 12  |     | 15  | ns       |
| t <sub>DOE</sub>                  | OE LOW to Data Valid                          |          | 5   |     | 6   |     | 7   | ns       |
| t <sub>LZOE</sub>                 | OE LOW to Low Z                               | 0        |     | 0   |     | 0   |     | ns       |
| t <sub>HZOE</sub>                 | OE HIGH to High Z <sup>[8, 9]</sup>           |          | 5   |     | 6   |     | 7   | ns       |
| t <sub>LZCE</sub>                 | CE LOW to Low Z <sup>[9]</sup>                | 3        |     | 3   |     | 3   |     | ns       |
| t <sub>HZCE</sub>                 | CE HIGH to High Z <sup>[8, 9]</sup>           |          | 5   |     | 6   |     | 7   | ns       |
| t <sub>PU</sub>                   | CE LOW to Power Up                            | 0        |     | 0   |     | 0   |     | ns       |
| t <sub>PD</sub>                   | CE HIGH to Power Down                         |          | 10  |     | 12  |     | 15  | ns       |
| Write Cycle                       | [10, 11]                                      |          | •   | •   | •   |     |     | •        |
| t <sub>WC</sub>                   | Write Cycle Time                              | 10       |     | 12  |     | 15  |     | ns       |
| t <sub>SCE</sub>                  | CE LOW to Write End                           | 7        |     | 8   |     | 10  |     | ns       |
| t <sub>AW</sub>                   | Address Setup to Write End                    | 7        |     | 8   |     | 10  |     | ns       |
| t <sub>HA</sub>                   | Address Hold from Write End                   | 0        |     | 0   |     | 0   |     | ns       |
| t <sub>SA</sub>                   | Address Setup to Write Start                  | 0        |     | 0   |     | 0   |     | ns       |
| t <sub>PWE</sub>                  | WE Pulse Width                                | 7        |     | 8   |     | 10  |     | ns       |
| t <sub>SD</sub>                   | Data Setup to Write End                       | 5        |     | 6   |     | 7   |     | ns       |
| t <sub>HD</sub>                   | Data Hold from Write End                      | 0        |     | 0   |     | 0   |     | ns       |
| t <sub>LZWE</sub>                 | WE HIGH to Low Z <sup>[9]</sup>               | 3        |     | 3   |     | 3   |     | ns       |
| t <sub>HZWE</sub>                 | WE LOW to High Z <sup>[8, 9]</sup>            |          | 5   |     | 6   |     | 7   | ns       |

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5 V, input pulse levels of 0 to 3.0 V.
   thower gives the minimum amount of time that the power supply should be at stable, typical V<sub>CC</sub> values until the first memory access can be performed.
   thacet, thacet, thacet, and thack are specified with a load capacitance of 5 pF as in part (d) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
   At any temperature and voltage condition, thacet is less than that the transition of either of the memory is defined by the overlap of CE LOW, and WE LOW. CE and WE must be LOW to initiate a Write, and the transition of either of these signals can terminate the Write. The input data setup and hold timing should be referenced to the leading edge of the signal that terminates the Write.
   The minimum Write cycle time for Write Cycle No. 3 (WE controlled, OE LOW) is the sum of that the transition of the terminates the Write.



## **Switching Waveforms**



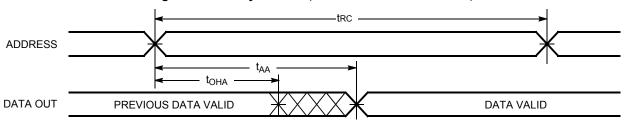


Figure 5. Read Cycle No. 2 (OE Controlled) [13, 14]

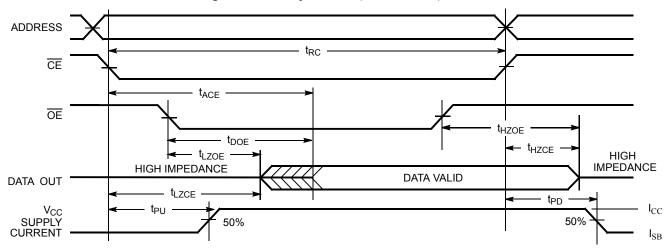
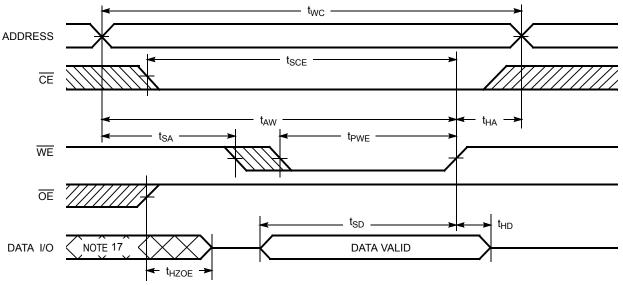


Figure 6. Write Cycle No. 1 (WE Controlled, OE HIGH During Write) [15, 16]



### Notes

- 12. <u>Device</u> is continuously selected. <u>OE</u>, <u>CE</u> = V<sub>IL</sub>.

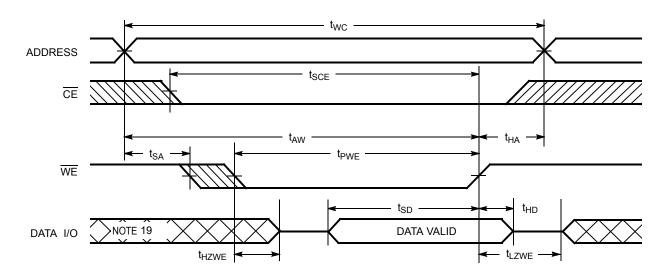
  13. <u>WE</u> is HIGH for read cycles.
- 14. Address valid before or similar to  $\overline{\text{CE}}$  transition LOW.
- 15. Data I/O is high impedance if  $\overline{OE}$  =  $V_{|\underline{H}|}$ .

  16. If  $\overline{CE}$  goes HIGH simultaneously with  $\overline{WE}$  HIGH, the output remains in high impedance state.
- 17. During this period, the I/Os are in output state. Do not apply input signals.



## **Switching Waveforms** (continued)

Figure 7. Write Cycle No. 2 ( $\overline{\text{WE}}$  Controlled,  $\overline{\text{OE}}$  LOW) [18]



## **Truth Table**

| CE | OE | WE | I/O <sub>0</sub> –I/O <sub>7</sub> | Mode                       | Power                      |
|----|----|----|------------------------------------|----------------------------|----------------------------|
| Н  | Х  | Х  | High Z                             | Power Down                 | Standby (I <sub>SB</sub> ) |
| L  | L  | Н  | Data Out                           | Read                       | Active (I <sub>CC</sub> )  |
| L  | Х  | L  | Data In                            | Write                      | Active (I <sub>CC</sub> )  |
| L  | Н  | Н  | High Z                             | Selected, Outputs Disabled | Active (I <sub>CC</sub> )  |

Notes

18. If  $\overline{\text{CE}}$  goes HIGH simultaneously with  $\overline{\text{WE}}$  HIGH, the output remains in high impedance state.

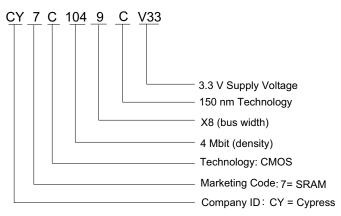
19. During this period, the I/Os are in output state. Do not apply input signals.



## **Ordering Information**

| Speed (ns) | Ordering Code       | Package<br>Diagram | Package Type                          | Operating<br>Range |
|------------|---------------------|--------------------|---------------------------------------|--------------------|
| 10         | CY7C1049CV33-10VXC  | 51-85090           | 36-Pin (400-Mil) Molded SOJ (Pb-free) | Commercial         |
|            | CY7C1049CV33-10VXA  | 51-85090           | 36-Pin (400-Mil) Molded SOJ (Pb-free) | Automotive-A       |
|            | CY7C1049CV33-10ZXC  | 51-85087           | 44-Pin TSOP II (Pb-free)              | Commercial         |
| 12         | CY7C1049CV33-12ZSXA | 51-85087           | 44-Pin TSOP II (Pb-free)              | Automotive-A       |
| 15         | CY7C1049CV33-15VXE  | 51-85090           | 36-Pin (400-Mil) Molded SOJ (Pb-free) | Automotive-E       |
|            | CY7C1049CV33-15ZSXE | 51-85087           | 44-Pin TSOP II (Pb-free)              | Automotive-E       |

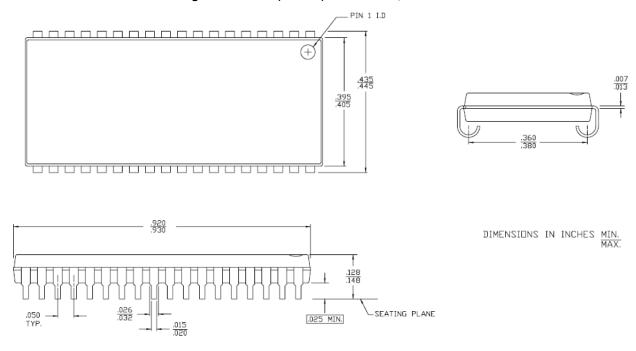
## **Ordering Code Definitions**





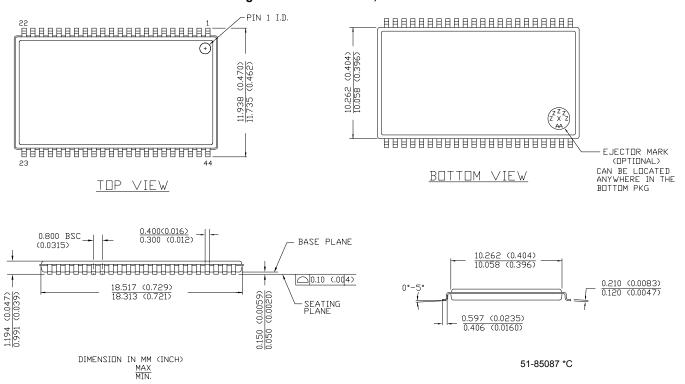
## **Package Diagrams**

Figure 8. 36-Pin (400-Mil) Molded SOJ, 51-85090



51-85090 \*D

Figure 9. 44-Pin TSOP II, 51-85087





## **Acronyms**

Table 1. Acronyms Used in this Document

| Acronym | Description               |
|---------|---------------------------|
| TR      | Thermal Resistance        |
| CE      | Chip Enable               |
| ŌĒ      | Output Enable             |
| RD      | Row Decoder               |
| IB      | Input Buffer              |
| RAM     | Random Access Memory      |
| I/O     | Input/Output              |
| MAT     | Maximum Access Time       |
| MOC     | Maximum Operating Current |



# **Document History Page**

| Document Title: CY7C1049CV33 4-Mbit (512K X 8) Static RAM Document Number: 38-05006 |         |                    |                    |   |
|---|---------|--------------------|--------------------|---|
| Rev.  | ECN     | Orig. of<br>Change | Submission<br>Date | Description of Change   |
| **  | 112569  | HGK                | 03/06/02           | New data sheet  |
| *A  | 114091  | DFP                | 04/25/02           | Changed Tpower unit from ns to μs   |
| *B  | 116479  | CEA                | 09/16/02           | Add applications foot note to data sheet, page 1.   |
| *C  | 262949  | RKF                | See ECN            | Added Automotive-E Specs Added $\Theta_{\rm JA}$ and $\Theta_{\rm JC}$ values on Page #3.   |
| *D  | 300091  | RKF                | See ECN            | Added -20-ns Speed bin  |
| *E  | 344595  | SYT                | See ECN            | Added Pb-free package on page #8 Removed shading for CY7C1049CV33-15ZSXE in the ordering Information on page 9  |
| *F  | 2615344 | VKN/PYRS           | 12/03/08           | Added Automotive-A information Removed 8 ns and 20 ns speed bins, Changed $t_{POWER}$ spec from 1 $\mu$ s to 100 $\mu$ s, Updated Ordering Information table. |
| *G  | 2841563 | NXR/               | 01/07/2010         | Added CY7C1049CV33-10VXA to Ordering Info table.  |
| *H  | 2898958 | AJU                | 03/25/10           | Removed inactive parts from the ordering information table. Updated package diagrams.   |
| *   | 2954734 | AJU                | 06/30/2010         | New Part Number added CY7C1049CV33-10ZXC to Ordering Info table.  |



## Sales, Solutions, and Legal Information

### Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

### **Products**

Automotive cypress.com/go/automotive Clocks & Buffers cypress.com/go/clocks Interface cypress.com/go/interface cypress.com/go/powerpsoc cypress.com/go/plc

Memory cypress.com/go/memory
Optical & Image Sensing cypress.com/go/image
PSoC cypress.com/go/psoc
Touch Sensing cypress.com/go/touch
USB Controllers cypress.com/go/USB
Wireless/RF cypress.com/go/wireless

### **PSoC Solutions**

psoc.cypress.com/solutions PSoC 1 | PSoC 3 | PSoC 5

© Cypress Semiconductor Corporation, 2002-2010. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress product. Nor does it convey or imply any license under patent or other rights. Cypress products are not warranted nor intended to be used for medical, life saving, critical control or safety applications, unless pursuant to an express written agreement with Cypress. Furthermore, Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress products in life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Any Source Code (software and/or firmware) is owned by Cypress Semiconductor Corporation (Cypress) and is protected by and subject to worldwide patent protection (United States and foreign), United States copyright laws and international treaty provisions. Cypress hereby grants to licensee a personal, non-exclusive, non-transferable license to copy, use, modify, create derivative works of, and compile the Cypress Source Code and derivative works for the sole purpose of creating custom software and or firmware in support of licensee product to be used only in conjunction with a Cypress integrated circuit as specified in the applicable agreement. Any reproduction, modification, translation, compilation, or representation of this Source Code except as specified above is prohibited without the express written permission of Cypress.

Disclaimer: CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS MATERIAL, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. Cypress reserves the right to make changes without further notice to the materials described herein. Cypress does not assume any liability arising out of the application or use of any product or circuit described herein. Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress' product in a life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Use may be limited by and subject to the applicable Cypress software license agreement.

Document #: 38-05006 Rev. \*I

Revised June 30, 2010

Page 13 of 13

All products and company names mentioned in this document may be the trademarks of their respective holders.